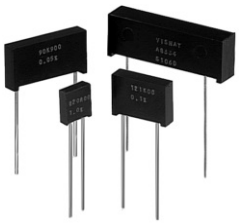
High Precision Foil Resistor with TCR of ± 2.0 ppm/°C, Tolerance of ± 0.005 % and Load Life Stability of ± 0.005 %



Any value at any tolerance available within resistance range

INTRODUCTION

Bulk Metal® Foil (BMF) technology outperforms all other resistor technologies available today for applications that require high precision and high stability.

This technology has been pioneered and developed by VISHAY, and products based on this technology are the most suitable for a wide range of applications. BMF technology allows us to produce customer orientated products, designed to satisfy challenging and specific technical requirements.

Model S Series made from Vishay BMF offers low TCR, excellent load life stability, tight tolerance, fast response time, low current noise, low thermal EMF and low voltage coefficient, all in one resistor.

The S Series is virtually insensitive to destabillizing factors. The resistor element is a solid alloy that displays the desirable bulk properties of its parent material, thus it is inherently stable and noise free.

Vishay's Bulk Metal® S Series resistors are the modern generation of precision resistors. The standard design of these resistors provides a unique combination of characteristics found in no other single resistor.

Our Application Engineering Department is available to advise and to make recommendations. For non-standard technical requirements and special applications, please contact us.

FEATURES

Pb-free Available

RoHS* COMPLIANT

- **Temperature coefficient of resistance (TCR): - 55 °C to + 125 °C, 25 °C ref.**
  - S102C series: ± 2 ppm/°C typical (see table 1)
  - S102K series: ± 1 ppm/°C typical (see table 1)
- Rated power: to 1 W at + 125 °C
- Tolerance: ± 0.005 %
- Load life stability: to ± 0.005 % at 70 °C, 2000 h at rated power
- Resistance range: 0.5 Ω to 1 MΩ (higher or lower values of resistance are available)
- Electrostatic discharge above 25 000 V
- Non inductive, non capacitive design
- Rise time: 1 ns without ringing
- Current noise: < - 40 dB
- Thermal EMF: 0.05 µV/°C typical
- Voltage coefficient: < 0.1 ppm/V
- Low inductance: < 0.08 µH typical
- Non hot spot design
- Terminal finishes available: lead (Pb)-free
  tin/lead alloy
- Matched sets are available per request (TCR Tracking: to 0.5 ppm/°C)
- For better TCR and PCR performances please review the **Z201** datasheet

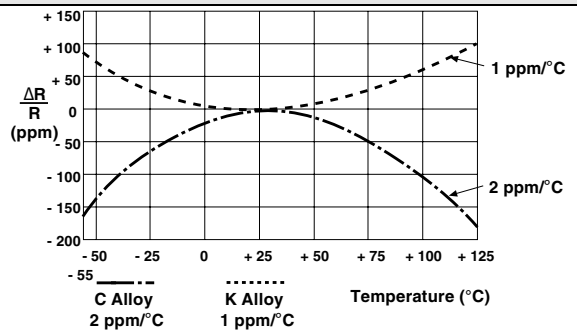
APPLICATIONS

- High precision amplifiers
- Down-hole (high temperature)
- High precision instrumentation
- Medical and test equipment
- Industrial
- Audio (high end stereo equipment)
- EB applications (electron beam scanning and recording equipment, electron microscopes)
- Military, airborne
- Measurement instrumentation

TABLE 1 - RESISTANCE VERSUS TCR
(- 55 °C to + 125 °C, + 25 °C Ref.)

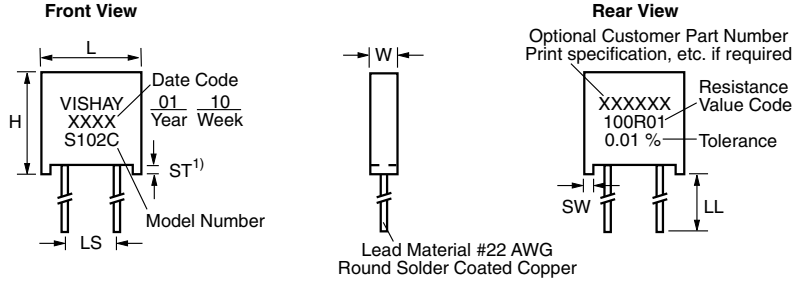
RESISTOR	RESISTANCE VALUE (Ω)	TYPICAL TCR AND MAX SPREAD (ppm/°C)
S102(C)	80 to < 150K	± 2 ± 2.5
S102(K)	80 to < 100K	± 1 ± 2.5
S102(C)	50 to < 80	± 2 ± 3.5
S102(K)		± 1 ± 3.5
S102(C)	1 to < 50	± 2 ± 4.5
S102(K)		± 1 ± 4.5

FIGURE 1 - FOIL RESISTOR TCR COMPARISON OF FOIL ALLOYS IN MILITARY RANGE



* Pb containing terminations are not RoHS compliant, exemptions may apply

FIGURE 2 - STANDARD IMPRINTING AND DIMENSIONS



Note

1. The standoffs shall be so located as to give a lead clearance of 0.010" minimum between the resistor body and the printed circuit board when the standoffs are seated on the printed circuit board. This is to allow for proper cleaning of flux and other contaminants from the unit after all soldering processes.

TABLE 2 - MODEL SELECTION

MODEL NUMBER	RESISTANCE RANGE (Ω)	MAXIMUM WORKING VOLTAGE	AMBIENT POWER RATING		AVERAGE WEIGHT IN GRAMS	DIMENSIONS			TIGHTEST TOLERANCE VS. LOWEST RESISTANCE VALUE
			at + 70 °C	at + 125 °C		INCHES	mm	F1) (INCHES)	
S102C (S102J)2)	1 to 150K	300	0.6 W up to 100K	0.3 W	0.6	W: 0.105 ± 0.010 L: 0.300 ± 0.010 H: 0.326 ± 0.010 ST: 0.010 min. SW: 0.035 ± 0.010 LL: 1.000 ± 0.125 LS: 0.150 ± 0.0054	2.67 ± 0.25 7.62 ± 0.25 8.28 ± 0.25 0.254 min. 1.02 ± 0.13 25.4 ± 3.18 3.81 ± 0.13		0.005 %/50 Ω 0.01 %/25 Ω 0.02 %/12 Ω 0.05 %/5 Ω 0.1 %/2 Ω 0.25 %/2 Ω 0.50 %/1 Ω 1.0 %/1 Ω
S102K (S102L)2)	1 to 100K		0.4 W over 100K	0.2 W					
S104D (S104F)1)	1 to 500K	350	1.0 W up to 200K	0.5 W	1.4	W: 0.160 max. L: 0.575 max. H: 0.413 max. ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.400 ± 0.020	4.06 max. 14.61 max. 10.49 max. 0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 10.16 ± 0.51	(0.138) (0.565) (0.413)	
S104K	1 to 300K		0.6 W over 200K	0.3 W					
S105D (S105F)1)	1 to 750K	350	1.5 W up to 300K	0.75 W	1.9	W: 0.160 max. L: 0.820 max. H: 0.413 max. ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.650 ± 0.020	4.06 max. 20.83 max. 10.49 max. 0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 16.51 ± 0.51	(0.138) (0.890) (0.413) (0.7 ± 0.02)	
S105K	1 to 500K		0.8 W over 300K	0.4 W					
S106D	0.5 to 1M	500	2.0 W up to 400K	1.0 W	4.0	W: 0.260 max. L: 1.200 max. H: 0.413 max. ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.900 ± 0.020	6.60 max. 30.48 max. 10.49 max. 0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 22.86 ± 0.51		
S106K	0.5 to 600K		1.0 W over 400K	0.5 W					

Notes

1. S104F and S105F have different package dimensions (see last column). All other specifications are the same.
2. 0.200" (5.08 mm) lead spacing available - specify S102J for S102C, and S102L for S102K.

FIGURE 3 - POWER DERATING CURVE

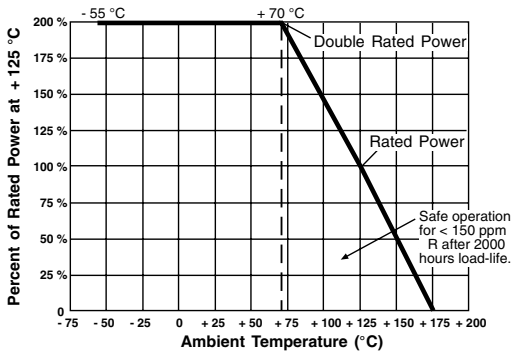
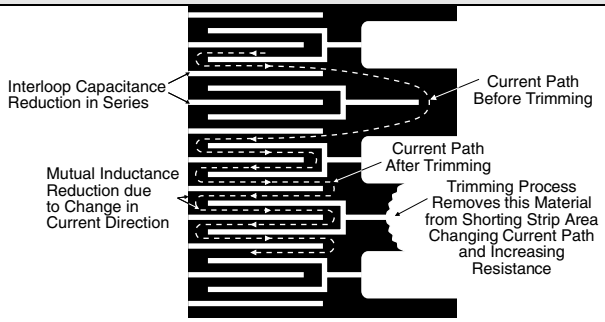


FIGURE 4 - TRIMMING TO VALUES
(Conceptual Illustration)



Note: Foil shown in black, etched spaces in white

TABLE 3 - ENVIRONMENTAL PERFORMANCE COMPARISON

	MIL-PRF-55182 CHAR J	S-SERIES MAXIMUM ΔR	S-SERIES TYPICAL ΔR
Test Group I			
Thermal shock, 5 x (- 65 °C to + 150 °C)	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Short time overload, 6.25 x rated power	± 0.2 %	± 0.01 % (100 ppm)	± 0.003 % (30 ppm)
Test Group II			
Resistance temperature characteristics	± 25 ppm/°C	± 4.5 ppm/°C	± 2.0 ppm/°C
Characteristic			
Low temperature storage (24 h at - 65 °C)	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Low temperature operation (45 min, rated power at - 65 °C)	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Terminal strength	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Test Group III			
DWV	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Resistance to solder heat	± 0.1 %	± 0.01 % (100 ppm)	± 0.005 % (50 ppm)
Moisture resistance	± 0.4 %	± 0.05 % (500 ppm)	± 0.01 % (100 ppm)
Test Group IV			
Shock	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Vibration	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)
Test Group V			
Life test at 0.3 W/+ 125 °C			
2000 h	± 0.5 %	± 0.015 % (150 ppm)	± 0.01 % (100 ppm)
10 000 h	± 2.0 %	± 0.05 % (500 ppm)	± 0.03 % (300 ppm)
Test Group Va			
Life test at 0.6 W (2 x rated power)/+ 70 °C, 2000 h	± 0.5 %	± 0.015 % (150 ppm)	± 0.01 % (100 ppm)
Test Group VI			
High temperature exposure (2000 h at + 175 °C)	± 2.0 %	± 0.1 % (1000 ppm)	± 0.05 % (500 ppm)
Test Group VII			
Voltage coefficient	5 ppm/V	< 0.1 ppm/V	< 0.1 ppm/V

STANDARD OPERATIONS AND TEST CONDITIONS

A. Standard Test Operations:

By 100 % Inspection

- Short-time overload (6.25 x rated power for 5 s)
- Resistance – tolerance check
- Visual and mechanical

By Sample Inspection

- TCR
- Environmental tests per table 3 on a quarterly basis to establish performance by similarity

B. Standard Test Conditions:

- Lead test point: 0.5" (12.7 mm) from resistor body
- Temperature: + 23 °C ± 2 °C
- Relative humidity: per MIL-STD-202

IMPROVED PERFORMANCE TESTING (IPT)

The preceding information is based on product directly off the production line. Improved performance (meaning increased time stability with load and other stresses) is available through factory conducted “Improved Performance Testing”. The test routine is usually tailored to the users stability objectives and product that has been screened can be brought down to a potential load life of less than 50 ppm.

Various screen test routines are available and all anticipated stresses must be taken into account before settling on one specific test routine. Our Applications Engineering Department is prepared to discuss and recommend appropriate routines given the full spectrum of anticipated stresses and stability requirements.

TABLE 4 - “S” SERIES SPECIFICATIONS

Stability[1)]		
Load life at 2000 h	± 0.015 % (150 ppm)	Maximum ΔR at 0.3 W/+ 125 °C
	± 0.005 % (50 ppm)	Maximum ΔR at 0.1 W/+ 70 °C
Load life at 10 000 h	± 0.05 % (500 ppm)	Maximum ΔR at 0.3 W/+ 125 °C
	± 0.01 % (100 ppm)	Maximum ΔR at 0.05 W/+ 125 °C
Current Noise	0.010 µV	(RMS)/V of applied voltage (- 40 dB)
High Frequency Operation		
Rise time	1.0 ns at 1 kΩ	
Inductance (L)[2)]	0.1 µH maximum; 0.08 µH typical	
Capacitance (C)	1.0 pF maximum; 0.5 pF typical	
Voltage Coefficient	< 0.1 ppm/V[3)]	
Thermal EMF[4)]	0.1 µV/°C	Maximum; 0.05 µV/°C typical
	1 µV/W	(Model S102C)

Notes

1. Load life ΔR maximum can be reduced by 80 %, please contact Applications Engineering Department.
2. Inductance (L) due mainly to the leads.
3. The resolution limit of existing test equipment (within the measurement capability of the equipment, or “essentially zero”.)
4. µV/°C relates to EMF due to lead temperature difference and µV/watt due to power applied to the resistor.

TABLE 5 - GLOBAL PART NUMBER INFORMATION

NEW GLOBAL PART NUMBER: Y000780K5000V9L (preferred part number format)

DENOTES PRECISION	VALUE	AER*
Y	**R** = Ω **K** = kΩ **M** = MΩ	**0** = standard **9** = lead (Pb)-free **1 - 999** = custom

Y	0	0	0	7	8	0	K	5	0	0	0	V	9	L

PRODUCT CODE	RESISTANCE TOLERANCE	PACKAGING
0007 = S102C **0785** = S102J **0062** = S102K **0786** = S102L **0011** = S104D **5011** = S104F **0101** = S104K **4101** = S104L **0012** = S105D **4012** = S105F **0102** = S105K **4102** = S105L **0013** = S106D **0103** = S106K	**V** = ± 0.005 % **T** = ± 0.01 % **Q** = ± 0.02 % **A** = ± 0.05 % **B** = ± 0.1 % **C** = ± 0.25 % **D** = ± 0.5 % **F** = ± 1.0 %	**L** = bulk pack

FOR EXAMPLE: ABOVE GLOBAL ORDER Y0007 80K5000 V 9 L:

TYPE: S102C
VALUE: 80.5 kΩ
ABSOLUTE TOLERANCE: ± 0.005 %
TERMINATION: lead (Pb)-free
PACKAGING: bulk pack

HISTORICAL PART NUMBER: S102C T 250R00 V B (will continue to be used)

S102C	T	250R00	V	B
MODEL	TERMINATION	RESISTANCE VALUE	TOLERANCE	PACKAGING
S102C **S102J** **S102K** **S102L** **S104D** **S104F** **S104K** **S104L** **S105D** **S105F** **S105K** **S105L** **S106D** **S106K**	**T** = lead (Pb)-free None = tin/lead alloy	**250R00** = 250.00 Ω **5K2310** = 5.231 kΩ **1M000** = 1 MΩ	**V** = ± 0.005 % **T** = ± 0.01 % **Q** = ± 0.02 % **A** = ± 0.05 % **B** = ± 0.1 % **C** = ± 0.25 % **D** = ± 0.5 % **F** = ± 1.0 %	**B** = bulk pack

Note

* For non-standard requests, please contact application engineering.

Notice

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